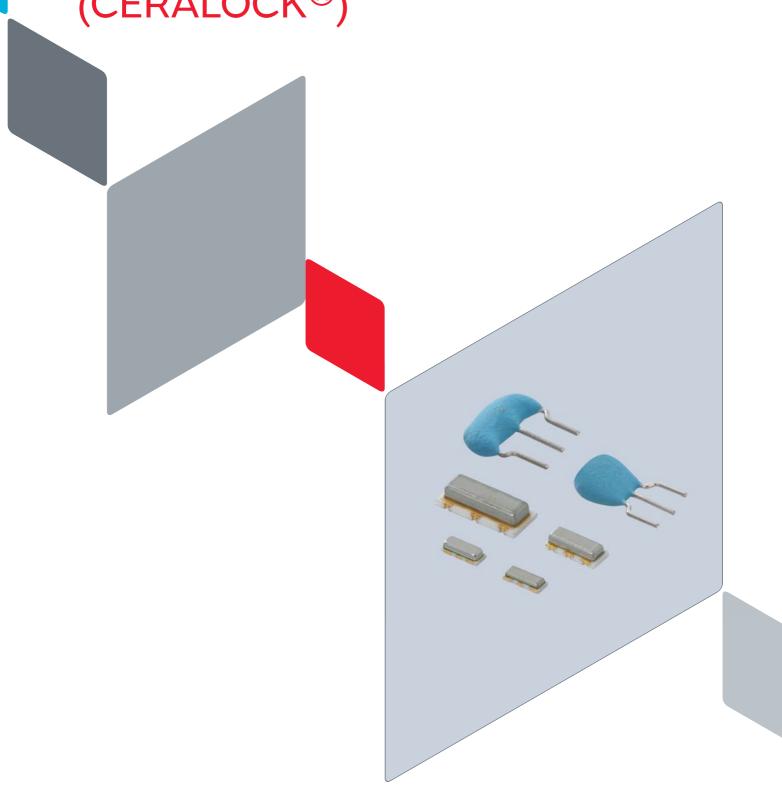
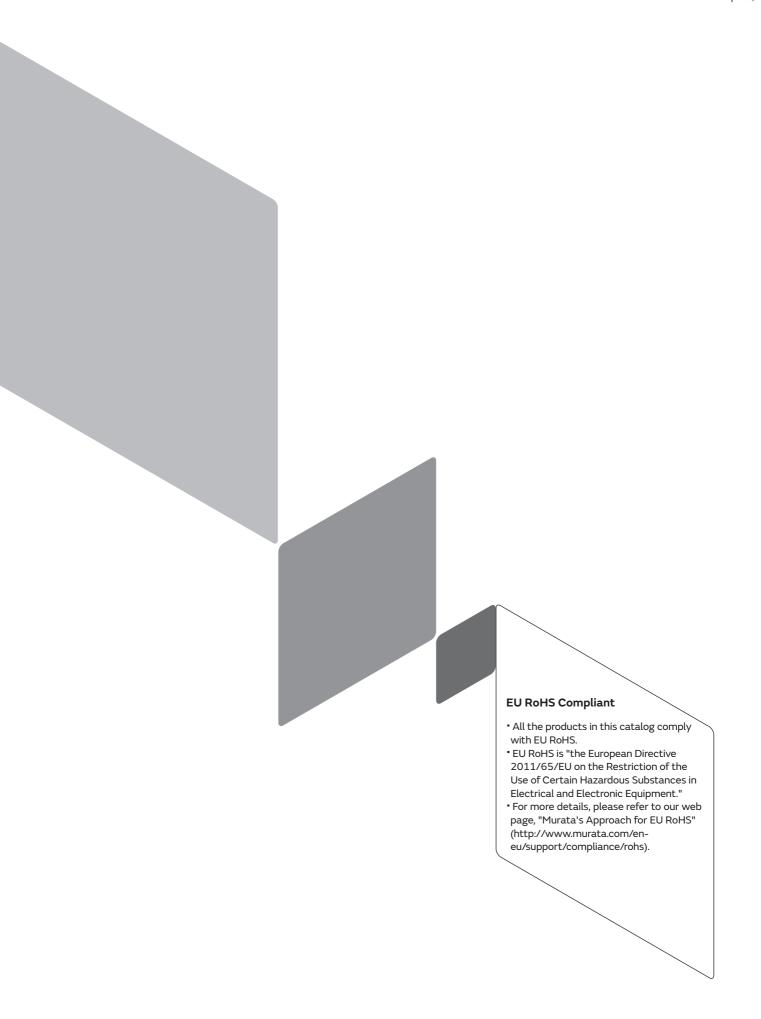


Ceramic Resonators (CERALOCK®)





Contents

Product specifications are as of $March\ 2017$.

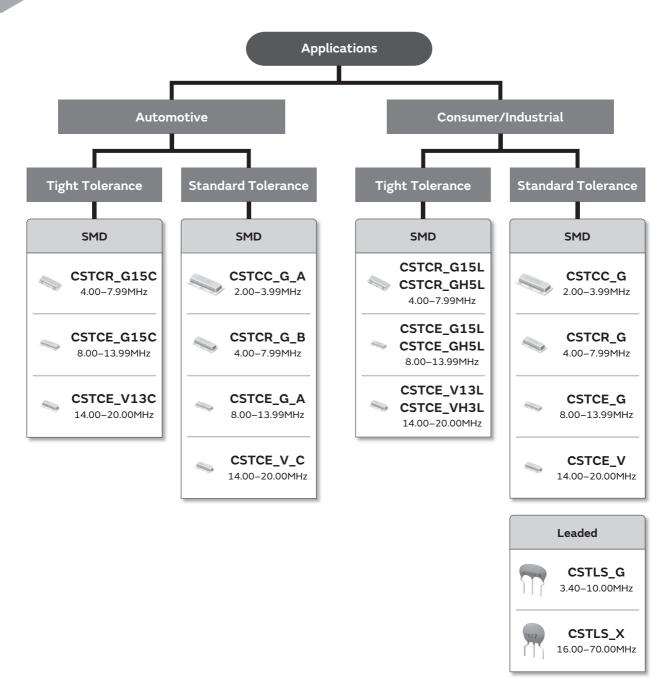
$$\label{eq:ceralock} \begin{split} &\text{CERALOCK}(^{\text{R}}), \text{CERALOCK}(^{\text{R}}) \text{ and "CERALOCK"} \\ &\text{in this catalog are the trademarks of} \\ &\text{Murata Manufacturing Co., Ltd.} \end{split}$$

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Please check the MURATA website (http://www.murata.com/) if you cannot find a part number in this catalog.

Selection

Selection Guide



Notice: "CERALOCK® for consumer" and "CERALOCK® for automotive" is different in the specification of Operating Temperature Range, Environmental Characteristics, Physical Characteristics and so on. Please choose either "for consumer" or "for automotive" according to the required specification.

Part Numbering

CERALOCK® (MHz)

1 Product ID

Product ID	
cs	Ceramic Resonators

2Frequency/Capacitance

Code	Frequency/Capacitance
Т	MHz with Built-in Capacitance

3Structure/Size

Code	Structure/Size
LS	Round Lead Type
СС	Cap Chip Type
CR/CE	Small-cap Chip Type

4 Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (Hz). Decimal point is expressed by capital letter ${}^{\rm H}$."

5Design

Code	Design
G	Thickness Shear mode
V	Thickness Expander mode

6Initial Frequency Tolerance

Code	Initial Frequency Tolerance
5	±0.5%
3	±0.3%
2	±0.2%
1	±0.1%
н	±0.07%

Capacity Output Description

Code	Load Capacity
1	5pF
2	10pF
3	15pF
5	33/39pF
6	47pF

8 Individual Specification

Code	Individual Specification	
***	Three-digit alphanumerics express	
	"Individual Specification."	

With standard products, "§Individual Specification" and "§Packaging" is omitted.

Packaging

Code	Packaging
-B0	Bulk
-A0	Radial Taping H₀=18mm
-R0/*R0	Plastic Taping ø=180mm Reel
-R1	Plastic Taping ø=330mm Reel

Radial taping is applied to lead type and plastic taping to chip type.

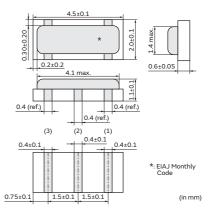
Ceramic Resonators (CERALOCK®)

Chip type CERALOCK® with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK® with built-in load capacitors.

This diverse series owes its development to MURATA's original mass production techniques and high reliability, and has achieved importance in the worldwide automotive market.

M

CSTCR_G15C 4.00-7.99MHz



Features

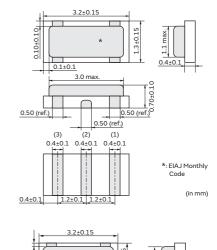
- 1. The series are high accuracy resonators whose total tolerance is available for less than ±3,000ppm.
- 2. The series has high reliability and is available for a wide temperature range.
- 3. Oscillation circuits do not require external load capacitors.
- 4. The series is available for a wide frequency range.
- 5. The resonators are extremely small and have a low profile.
- 6. No adjustment is necessary for oscillation circuits.

Applications

- 1. Cluster panel and Control panel
- 2. Safety control Anti-lock Brake System, Electronic Stability Control, Airbag, etc.
- 3. Engine ECU, Electronic Power Steering, Immobilizer, etc.
- 4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
- 5. Intelligent Transportation System
 Lane Keeping System, Millimeter wave radar, etc.
- 6. Battery control for hybrid cars

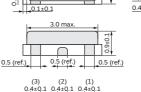


CSTCE_G15C 8.00-13.99MHz





CSTCE_V13C 14.00-20.00MHz

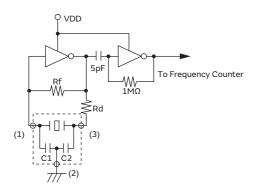


(3) (2) (1) 0.4±0.1 0.4±0.1 0.4±0.1	
	*: EIAJ Monthly Code
0.4±0.1 1.2±0.1 1.2±0.1	(in mm)

Part Number	Frequency (MHz)	Initial Frequency Tolerance (%)	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15C	4.00 to 7.99	±0.1	±0.13	-40 to 125
CSTCE_G15C	8.00 to 13.99	±0.1	±0.13	-40 to 125
CSTCE_V13C	14.00 to 20.00	±0.1	±0.13	-40 to 125

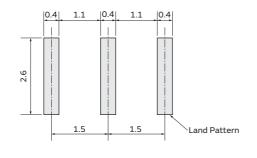
Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

Measuring Circuit of Oscillating Frequency



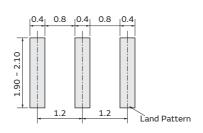
Standard Land Pattern Dimensions

CSTCR_G15C (* This Land Pattern is not common to CSTCR_G.)



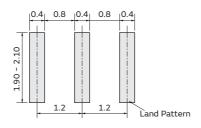
CSTCE_G15C

.....



(in mm)

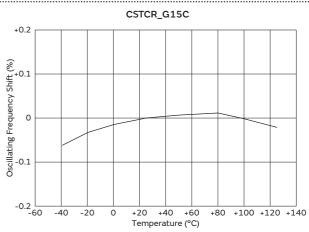
CSTCE_V13C (* This Land Pattern is not common to CSTCE_V.)

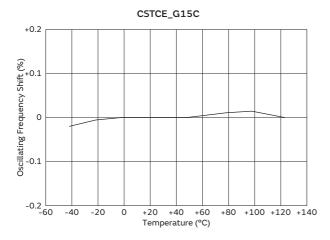


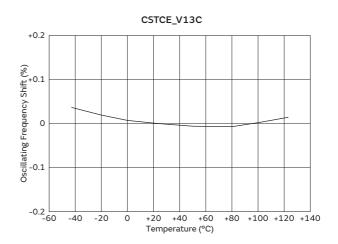
(in mm)

(in mm)

Frequency Temperature Characteristics

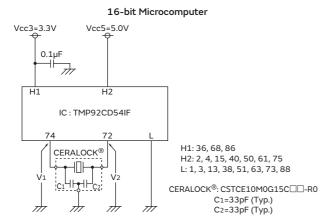




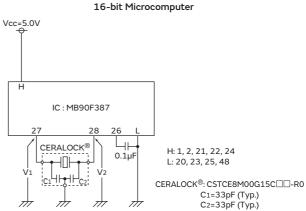


Application Circuits Utilization

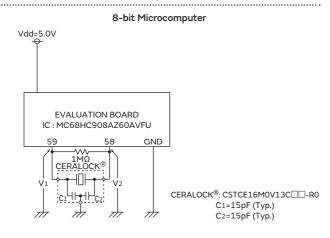
TMP92CD54IF (Toshiba)



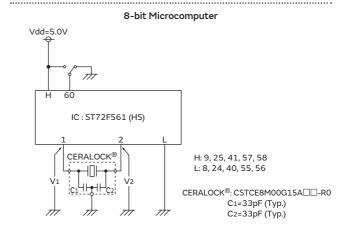
MB90F387 (Fujitsu)



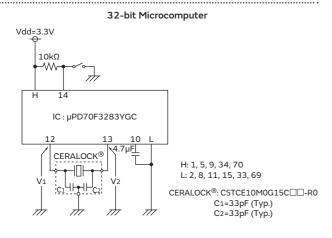
MC68HC908AZ60AVFU (Freescale)



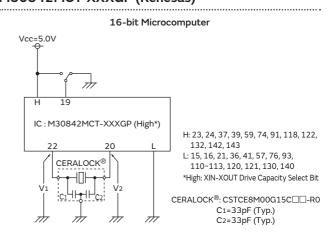
ST72F561 (HS) (ST Microelectronics)



μPD70F3283YGC (Renesas)



M30842MCT-XXXGP (Renesas)



Ceramic Resonators (CERALOCK®)

■ MHz Chip Type -Standard Frequency Tolerance for Automotive

Chip type CERALOCK® with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK® with built-in load capacitors.

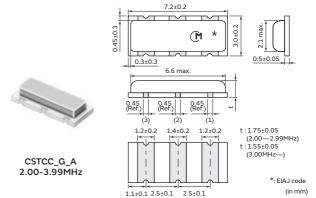
This diverse series owes its development to MURATA's original mass production techniques and high reliability, and has achieved importance in the worldwide automotive market.

Features

- 1. The series has high reliability and is available for a wide temperature range.
- 2. Oscillation circuits do not require external load capacitors.
- 3. The series is available in a wide frequency range.
- 4. The resonators are extremely small and have a low profile.
- 5. No adjustment is necessary for oscillation circuits.

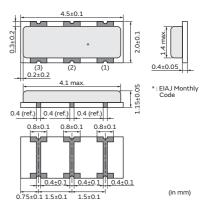
Applications

- 1. Cluster panel and Control panel
- Safety control
 Anti-lock Brake System, Electronic Stability Control,
 Airbag, etc.
- 3. Engine ECU, Electronic Power Steering, Immobilizer, etc.
- 4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
- 5. Electronic Toll Collection system, Car Navigation, etc.



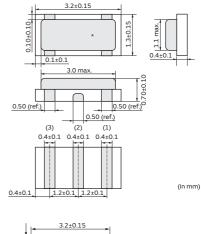


CSTCR_G_B 4.00-7.99MHz



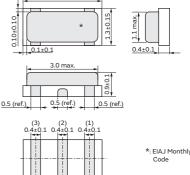


CSTCE_G_A 8.00-13.99MHz





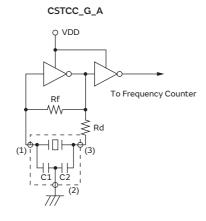
CSTCE_V_C 14.00-20.00MHz

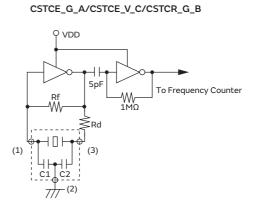


Part Number	Frequency (MHz)	Initial Frequency Tolerance (%)	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G_A	2.00 to 3.99	±0.5	± 0.4 [-0.6% to +0.3%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-40 to 125
CSTCR_G_B	4.00 to 7.99	±0.5	±0.15	-40 to 125
CSTCE_G_A	8.00 to 13.99	±0.5	±0.2	-40 to 125
CSTCE_V_C	14.00 to 20.00	±0.5	±0.15	-40 to 125

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

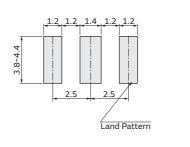
Measuring Circuit of Oscillating Frequency





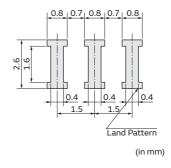
Standard Land Pattern Dimensions

CSTCC_G_A CSTCR_G_B

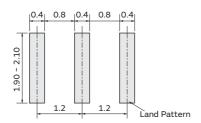


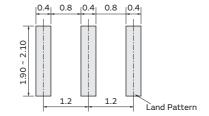
CSTCE_G_A

(in mm)



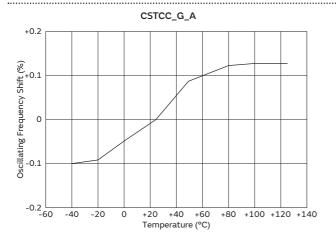
CSTCE_V_C
(* This Land Pattern is not common to CSTCE_V.)

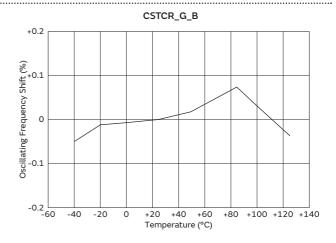


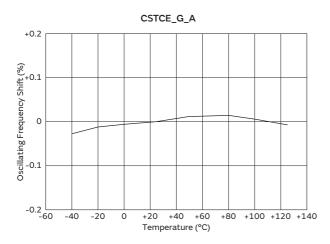


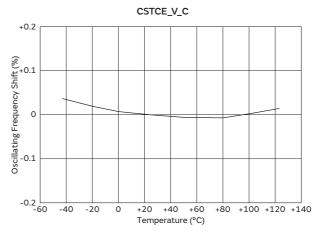
(in mm) (in mm)

Frequency Temperature Characteristics





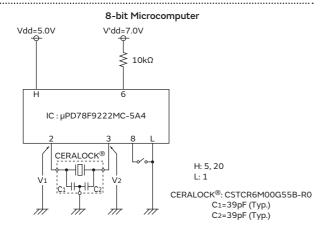




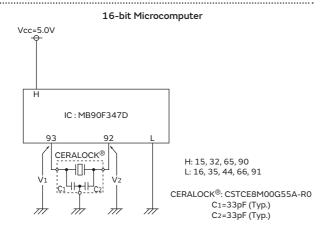
9

Application Circuits Utilization

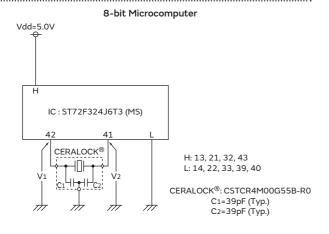
μPD78F9222MC-5A4 (Renesas)



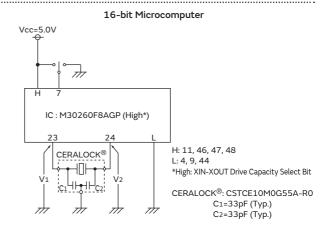
MB90F347D (Fujitsu)



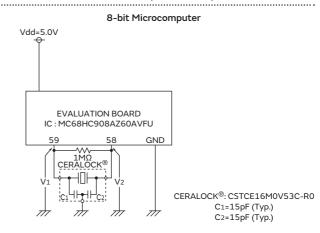
ST72F324J6T3 (MS) (ST Microelectronics)



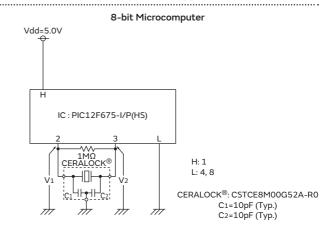
M30260F8AGP (Renesas)



MC68HC908AZ60AVFU (Freescale)



PIC12F675-I/P (HS) (Microchip)



Notice for Automotive

Soldering and Mounting (CSTCC_G_A, CSTCR_G_B/G15C, CSTCE_G_A/G15C, CSTCE_V_C/V13C Series)

1. Soldering

(1) Reflow soldering

Please mount the component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Darl Tanananahan	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using a soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron 350°C max.		
Watt	30W max.	
Shape of the soldering iron	ø3mm max.	
Soldering Time	5s max. at one terminal	
Solder	Sn-3.0Ag-0.5Cu	

(3) Solder Volume

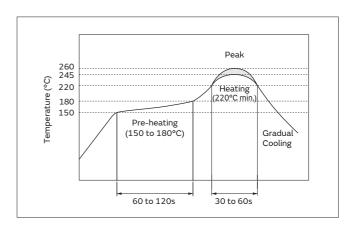
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.



Continued on the following page. 🖊

Notice for Automotive

Continued from the preceding page.

2. Wash

(1) Cleaning Solvents

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1 dT≤60°C (dT=Component-solvent)

*1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.

(3) Conditions

(a) Ultrasonic Wash

1 minute max. in above solvent at +60°C max. (Frequency: 28kHz, Output: 20W/l)

(4) Drying

5 minutes max. by blowing air at +80°C max.

- (5) Other
 - (a) Total washing time should be within 10 minutes.
 - (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.
- 3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.

- (b) Immersion Wash
 5 minutes max. in above solvent at +60°C max.
- (c) Shower or Rinse Wash 5 minutes max. in above solvent at +60°C max.

Continued on the following page. **7**

Notice for Automotive

Continued from the preceding page.

Storage and Operating Conditions

Product Storage Conditions
 Please store the products in a room where the temperature/humidity is stable, and avoid places where there are large temperature changes.

 Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

- 2. Expiration Date on Storage Expiration date (shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty.
 - Please confirm solderability and characteristics for the products regularly.
- 3. Notice on Product Storage
- (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage in a chemical atmosphere.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm that stable electrical characteristics are maintained.

Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

Packaging for Automotive

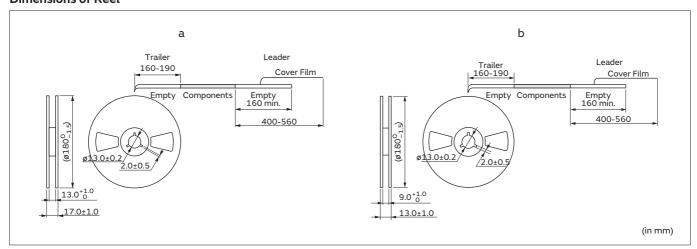
Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Reel Dimensions
CSTCC_G_A	2,000	6,000	500	a
CSTCR_G_B	3,000	9,000	500	a
CSTCR_G15C	3,000	9,000	500	a
CSTCE_G_A	3,000	9,000	500	b
CSTCE_G15C	3,000	9,000	500	b
CSTCE_V_C	3,000	9,000	500	b
CSTCE_V13C	3,000	9,000	500	b

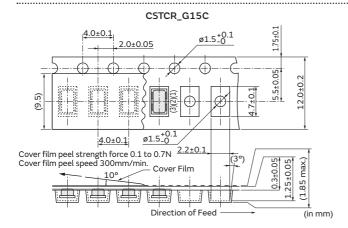
The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

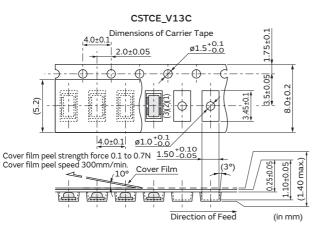
(pcs.)

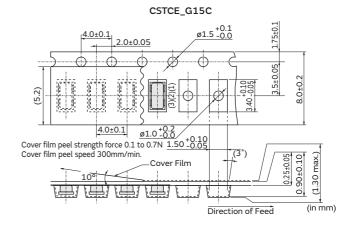
Dimensions of Reel

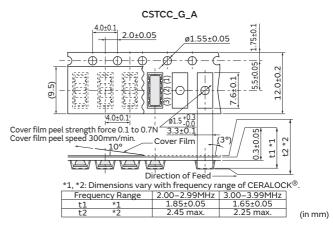


Dimensions of Taping







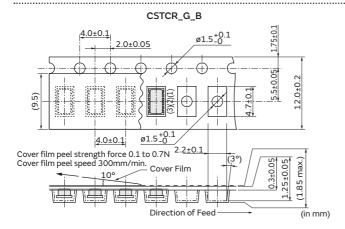


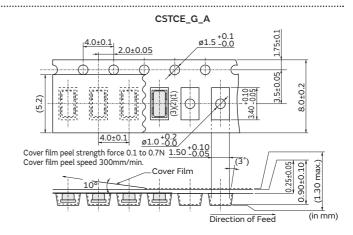
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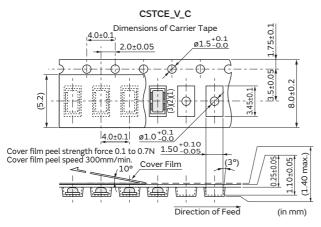
Packaging for Automotive

Continued from the preceding page.

Dimensions of Taping







Ceramic Resonators (CERALOCK®)

Chip type CERALOCK® with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and packaging technology expertise has enabled the development of the chip CERALOCK® with built-in load capacitors.

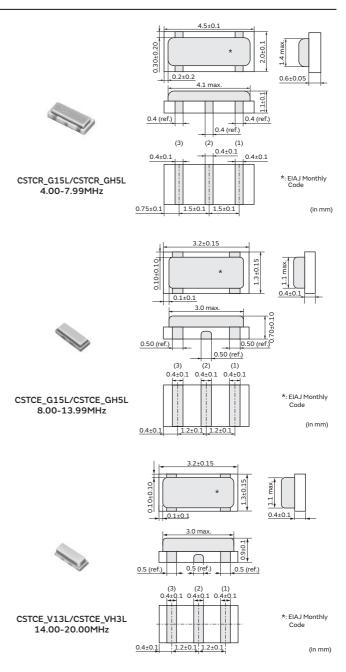
High-density mounting is made possible by the small package and the elimination of the need for an external load capacitor.

Features

- 1. Oscillation circuits do not require external load capacitors.
- 2. Available in a wide frequency range.
- 3. Extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

Applications

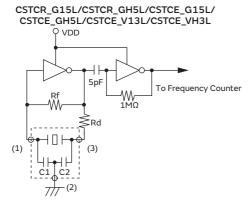
- 1. Clock oscillators for USB (full-speed) controller ICs
- 2. Audio equipment and musical instruments, etc.
- Other applications for replacement of Crystal units/ Oscillators



Part Number	Frequency (MHz)	Initial Frequency Tolerance (%)	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15L	4.00 to 7.99	±0.1	±0.08	0 to 70
CSTCR_GH5L	4.00 to 7.99	±0.07	±0.08	0 to 70
CSTCE_G15L	8.00 to 13.99	±0.1	±0.08	0 to 70
CSTCE_GH5L	8.00 to 13.99	±0.07	±0.08	0 to 70
CSTCE_V13L	14.00 to 20.00	±0.1	±0.08	0 to 70
CSTCE_VH3L	14.00 to 20.00	±0.07	±0.08	0 to 70

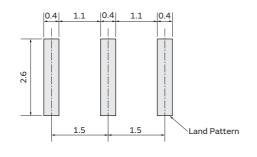
Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

Measuring Circuit of Oscillating Frequency

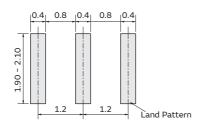


Standard Land Pattern Dimensions

CSTCR_G15L/CSTCR_GH5L (* This Land Pattern is not common to CSTCR_G.)

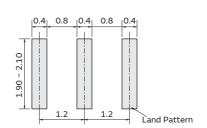


(in mm) (in mm)

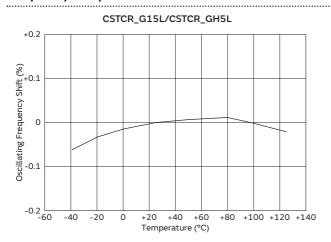


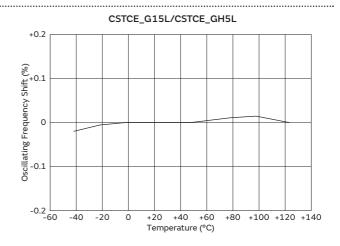
(in mm)

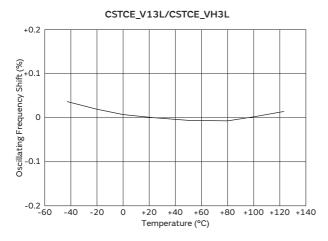
CSTCE_G15L/CSTCE_GH5L



Frequency Temperature Characteristics

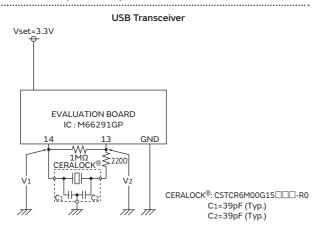




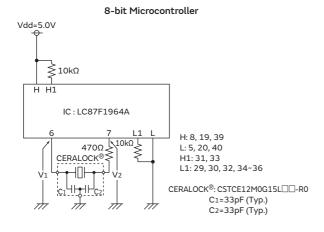


Application Circuits Utilization

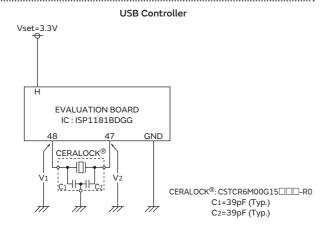
M66291GP (Renesas)



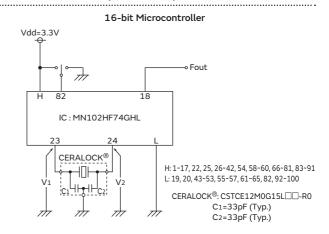
LC87F1964A (Sanyo)



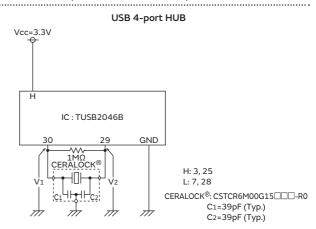
ISP1181BDGG (Philips)



MN102HF74GHL (Panasonic)



TUSB2046B (Texas Instruments)



Ceramic Resonators (CERALOCK®)

■ MHz Chip Type -Standard Frequency Tolerance for Consumer/Industrial Usage

Chip type CERALOCK® with built-in load capacitors provides an extremely small package.

MURATA's package technology expertise has enabled the development of the Chip CERALOCK $^{\circledR}$ with built-in load capacitors.

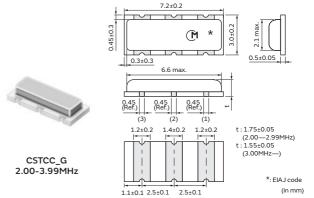
High-density mounting can be realized because of the small package and the elimination of the need for an external load capacitor.

Features

- 1. Oscillation circuits do not require external load capacitors.
- 2. Available in a wide frequency range.
- 3. Extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

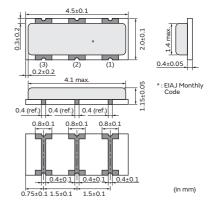
Applications

- 1. Clock oscillators for microprocessors
- Small electronic equipment such as handheld phone, digital video camcorder (DVC), digital still camera (DSC), portable audio player, etc.
- 3. Storage media and memory (HDD, Optical storage device, FDD, Flash memory card, etc.)
- 4. Office automation equipment (Mobile PC, Mouse, Keyboard, etc.)
- Audio-visual applications (TV, DVD-HDD recorder, Audio equipment, Remote control, etc.)
- 6. Home appliances (Air conditioner, Microwave oven, Refrigerator, Washing machine, etc.)



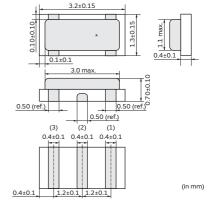


CSTCR_G 4.00-7.99MHz



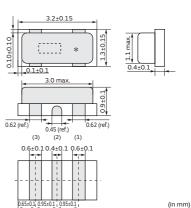


CSTCE_G/CSTCE_G_Z 8.00-13.99MHz





CSTCE_V 14.00-20.00MHz

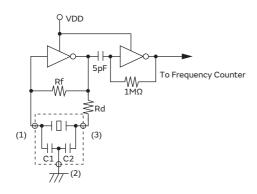


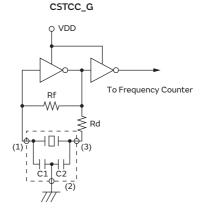
Part Number	Frequency (MHz)	Initial Frequency Tolerance (%)	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G	2.00 to 3.99	±0.5	±0.3 [±0.4%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-20 to 80
CSTCR_G	4.00 to 7.99	±0.5	±0.2	-20 to 80
CSTCE_G	8.00 to 13.99	±0.5	±0.2	-20 to 80
CSTCE_G_Z	8.00 to 13.99	±0.5	±0.2	-40 to 125
CSTCE_V	14.00 to 20.00	±0.5	±0.3	-20 to 80

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

Measuring Circuit of Oscillating Frequency

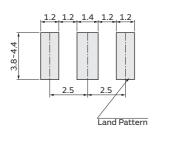






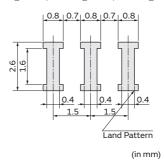
Standard Land Pattern Dimensions

CSTCC_G

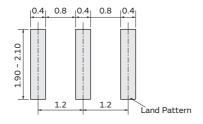


(in mm)

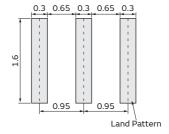
CSTCR_G
(* This Land Pattern is not common to
CSTCR_G15C, CSTCR_G15L, CSTCR_GH5L.)



CSTCE_G/CSTCE_G_Z

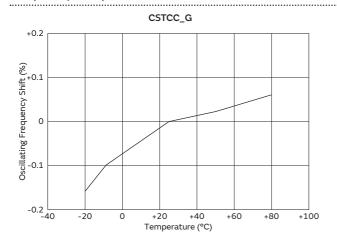


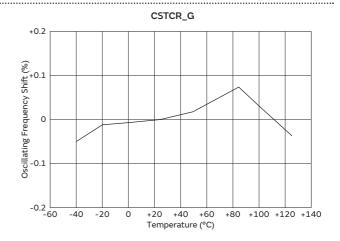
CSTCE_V
(* This Land Pattern is not common to
CSTCE_V13C, CSTCE_V_C, CSTCE_V13L, CSTCE_VH3L.)

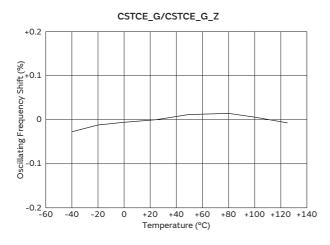


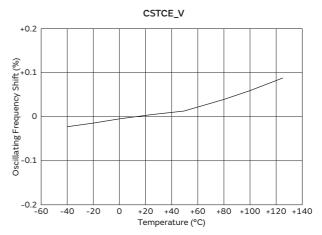
(in mm) (in mm)

Frequency Temperature Characteristics



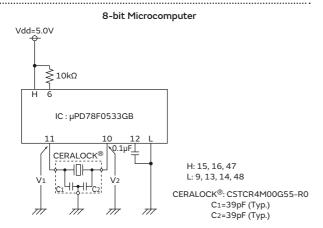




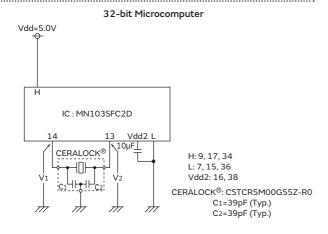


Application Circuits Utilization

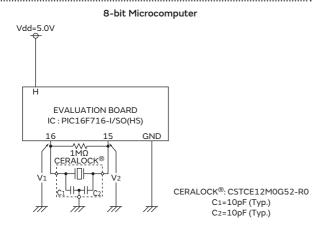
μPD78F0533GB (Renesas)



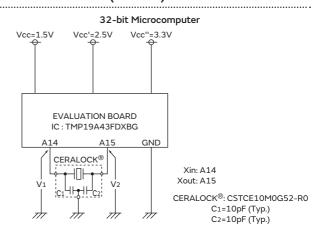
MN103SFC2D (Panasonic)



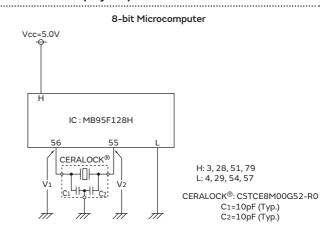
PIC16F716-I/SO (Microchip)



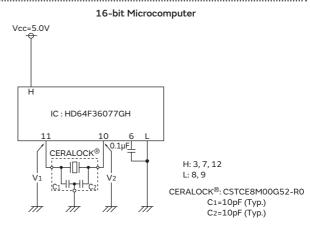
TMP19A43FDXBG (Toshiba)



MB95F128H (Fujitsu)



HD64F36077GH (Renesas)

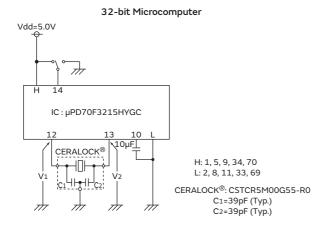


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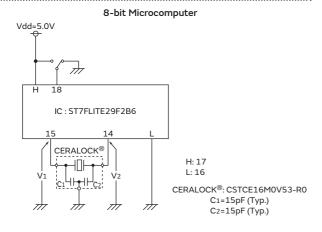
Application Circuits Utilization

Continued from the preceding page.

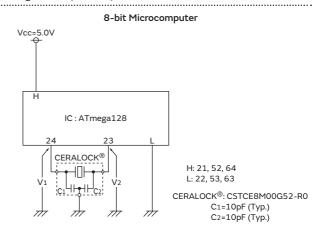
μPD70F3215HYGC (Renesas)



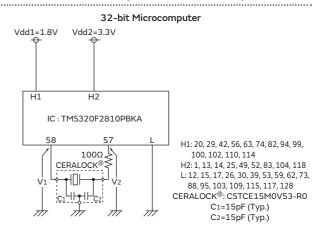
ST7FLITE29F2B6 (ST Microelectronics)



ATmega128 (Atmel)



TMS320F2810PBKA (Texas Instruments)



Ceramic Resonators (CERALOCK®)

■ MHz Lead Type -Standard Frequency Tolerance for Consumer/Industrial Usage

MURATA's ceramic resonator, CERALOCK® with built-in load capacitors, has been widely applied as the most suitable component for clock oscillators in a broad range of microprocessors.

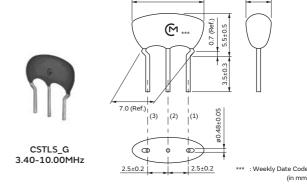
The CSTLS series can be used in the design of oscillation circuits not requiring external load capacitors, enabling both high-density mounting and cost reduction.

Features

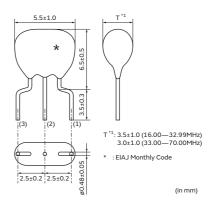
- Oscillation circuits do not require external load capacitors.
 There is some variation in built-in capacitance values applicable to various IC.
- 2. Stable over a wide temperature range.
- 3. Compact, lightweight and exhibit superior shock resistance performance.
- 4. Enable the design of oscillator circuits requiring no adjustment.
- 5. Cost-effective and reliable availability

Applications

- DTMF generators
- 2. Clock oscillators for microcomputers
- 3. Remote control units
- 4. Automated office equipment





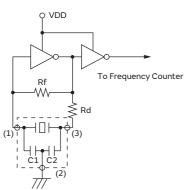


Part Number	Frequency (MHz)	Initial Frequency Tolerance (%)	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTLS_G	3.40 to 10.00	±0.5	±0.2 [-0.4% to +0.2%:Built-in Capacitance 47pF type]	-20 to 80
CSTLS_X	16.00 to 70.00	±0.5	±0.2	-20 to 80

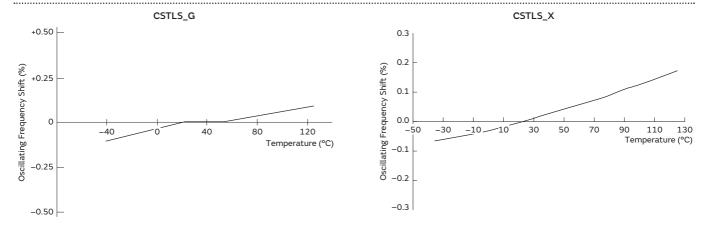
Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use. The order quantity should be an integral multiple of the "Minimum Quantity" shown on the packaging page.

Measuring Circuit of Oscillating Frequency

32-bit Microcomputer



Frequency Temperature Characteristics

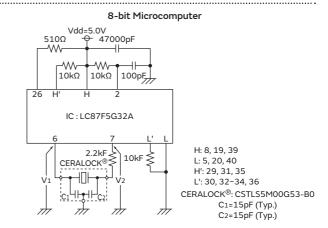


Application Circuits Utilization

M38235G6HP (Renesas)

8-bit Microcomputer Vcc=5.0V H 25 M38235G6HP 28 29 L CERALOCK® CERALOCK®: CSTLS8M00G53-B0 C1=15pF (Typ.) C2=15pF (Typ.)

LC87F5G32A (Sanyo)



Soldering and Mounting (CSTCC_G Series)

1. Soldering

(1) Reflow soldering

Please mount the component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Darl Tanananahan	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using a soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron 350°C max.		
Watt	30W max.	
Shape of the soldering iron	ø3mm max.	
Soldering Time	5s max. at one terminal	
Solder	Sn-3.0Ag-0.5Cu	

(3) Solder Volume

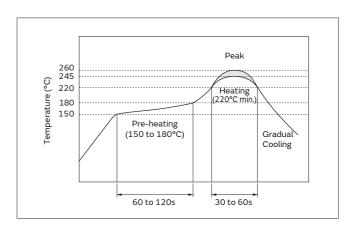
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.



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2. Wash

Some series do not withstand washing. Please check the list at right before use.

(1) Cleaning Solvents

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1 dT≤60°C (dT=Component-solvent)

*1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.

(3) Conditions

(a) Ultrasonic Wash

1 minute max. in above solvent at +60°C max. (Frequency: 28kHz, Output: 20W/l)

(4) Drying

5 minutes max. by blowing air at +80°C max.

(5) Other

- (a) Total washing time should be within 10 minutes.
- (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.

Series	Wash
CSTCC (2.00 to 3.49MHz)	Not Available
CSTCC (3.50 to 3.99MHz)	Available

(b) Immersion Wash

5 minutes max. in above solvent at +60°C max.

(c) Shower or Rinse Wash

5 minutes max. in above solvent at +60°C max.

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Continued from the preceding page.

Storage and Operating Conditions

Product Storage Conditions
 Please store the products in a room where the temperature/humidity is stable, and avoid places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

- 2. Expiration Date on Storage Expiration date (shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics for the products regularly.
- 3. Notice on Product Storage
- (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage in a chemical atmosphere.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating or washing of the component is not acceptable because it is not hermetically sealed.

Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

Soldering and Mounting (CSTCR_G/G15L/GH5L, CSTCE_G/G15L/GH5L, CSTCE_V/V13L/VH3L Series)

1. Soldering

(1) Reflow soldering

Please mount the component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s	
Heating	220°C min.	30 to 60s	
Peak Temperature	upper limit: 260°C	1s max.	
	lower limit: 245°C	5s max.	

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using a soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.		
Watt	30W max.		
Shape of the soldering iron	ø3mm max.		
Soldering Time	5s max. at one terminal		
Solder	Sn-3.0Ag-0.5Cu		

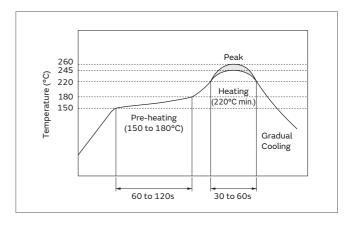
(3) Solder Volume

Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

2. Washing / Coating

Conformal coating or washing of the component is not acceptable, because it is not hermetically sealed.

Please contact us if you need a washable component.



(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

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Continued from the preceding page.

Storage and Operating Conditions

Product Storage Conditions
 Please store the products in a room where the temperature/humidity is stable, and avoid places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

- 2. Expiration Date on Storage Expiration date (shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics for the products regularly.
- 3. Notice on Product Storage
- (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage in a chemical atmosphere.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating or washing of the component is not acceptable because it is not hermetically sealed.

Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

Soldering and Mounting (CSTLS_G, CSTLS_X Series)

The component cannot withstand washing.

Please do not apply excessive mechanical stress to the component and lead terminals during soldering.

Storage and Operating Conditions

- Product Storage Conditions
 Please store the products in a room where the temperature/humidity is stable, and avoid places where there are large temperature changes. Please store the products under the following conditions:
 - Temperature: -10 to +40°C Humidity: 15 to 85% R.H.
- 2. Expiration Date on Storage Expiration date (shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics for the products regularly.
- 3. Notice on Product Storage
- (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage in a chemical atmosphere.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating or washing of the component is not acceptable because it is not hermetically sealed. Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

Packaging for Consumer/Industrial Usage -MHz Chip Type

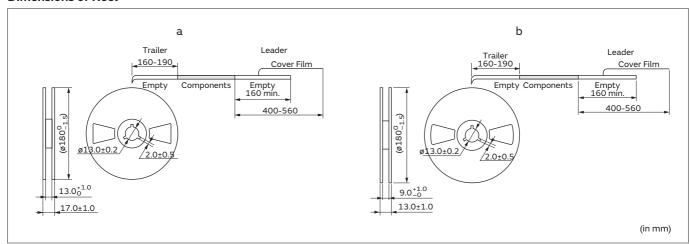
Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Reel Dimensions
CSTCC_G	2,000	6,000	500	a
CSTCR_G	3,000	9,000	500	a
CSTCR_G15L	3,000	9,000	500	a
CSTCR_GH5L	3,000	9,000	500	a
CSTCE_G	3,000	9,000	500	b
CSTCE_G15L	3,000	9,000	500	b
CSTCE_GH5L	3,000	9,000	500	b
CSTCE_V	3,000	9,000	500	b
CSTCE_V13L	3,000	9,000	500	b
CSTCE_VH3L	3,000	9,000	500	b

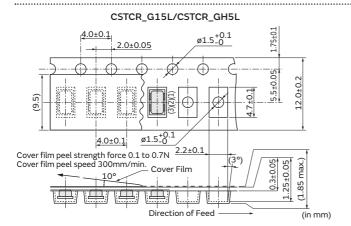
The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

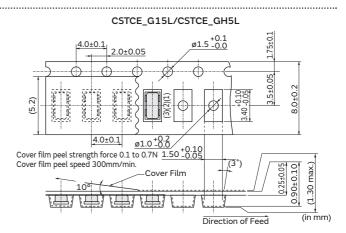
(pcs.)

Dimensions of Reel



Dimensions of Taping



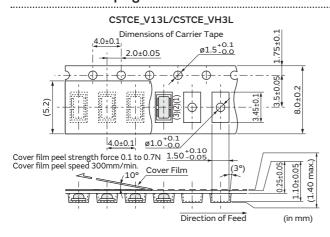


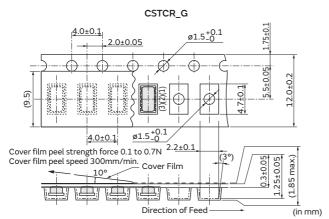
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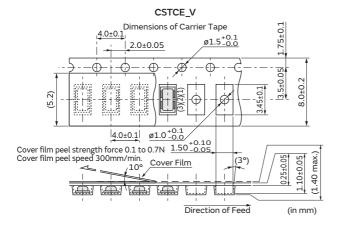
Packaging for Consumer/Industrial Usage -MHz Chip Type

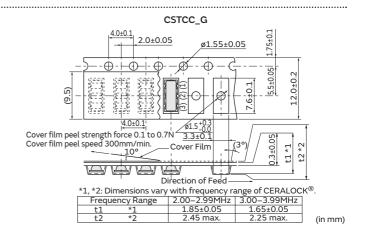
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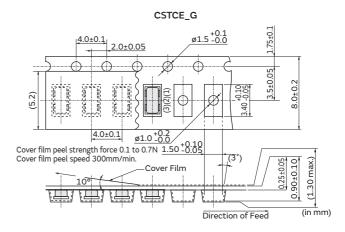
Dimensions of Taping











Packaging for Consumer/Industrial Usage -MHz Lead Type

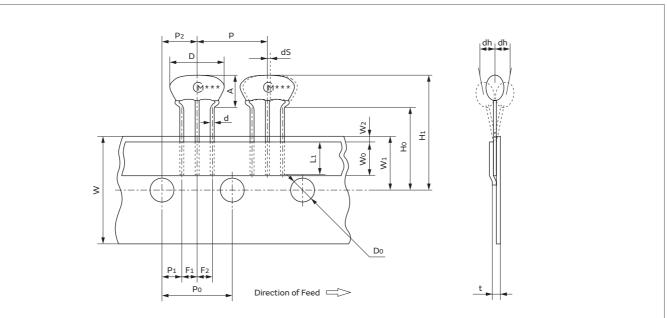
Minimum Quantity

Part Number	Ammo Pack	Bulk		
CSTLS_G (3.40 to 10.0MHz)	2,000	500		
CSTLS_X (16.00 to 70.00MHz)	2,000	500		

The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

(pcs.)

Tape Dimensions of CSTLS_G



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	8.0	±1.0	
Height of resonator	А	5.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L1	5.0 min.	-	
Pitch of component	Р	12.7	±0.5	Tolerance for Pitches 10xP0=127±1
Pitch of sprocket hole	Po	12.7	±0.2	
Length from sprocket hole center to lead	P1	3.85	±0.5	
Length from sprocket hole center to component center	P ₂	6.35	±0.5	
Lead spacing (I)	F1	2.5	±0.2	
Lead spacing (II)	F2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	Wo	6.0 min.	-	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W1	9.0	±0.5	
Gap of hold down tape and carrier tape	W2	0	+0.5 -0	
Distance between the center of sprocket hole and lead stopper	Ho	18.0	±0.5	
Total height of resonator	H1	23.5	±1.0	
Diameter of sprocket hole	Do	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

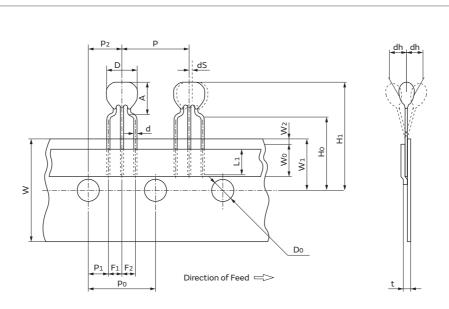
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(in mm)

Packaging for Consumer/Industrial Usage -MHz Lead Type

Continued from the preceding page.

Tape Dimensions of CSTLS_X



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	5.5	±1.0	
Height of resonator	А	6.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L1	5.0 min.	-	
Pitch of component	Р	12.7	±0.5	Tolerance for Pitches 10xP0=127±1
Pitch of sprocket hole	Po	12.7	±0.2	
Length from sprocket hole center to lead	P1	3.85	±0.5	
Length from sprocket hole center to component center	P ₂	6.35	±0.5	
Lead spacing (I)	F1	2.5	±0.2	
Lead spacing (II)	F2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	Wo	6.0 min.	_	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W1	9.0	±0.5	
Gap of hold down tape and carrier tape	W2	0	+0.5 -0.0	
Distance between the center of sprocket hole and lead stopper	Ho	18.0	±0.5	
Total height of resonator	H1	24.5	±1.0	
Diameter of sprocket hole	Do	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

Global Locations

For details please visit www.murata.com



⚠ Note

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 - Aerospace equipment
 - 3 Undersea equipment
 - Power plant equipment
 - Medical equipment
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 - Traffic signal equipment
 - (3) Disaster prevention / crime prevention equipment
 - Data-processing equipment
 - Application of similar complexity and/or reliability requirements to the applications listed above

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